

High Current Density Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

 Ultra Low $V_F = 0.47$ V at $I_F = 5$ A

 eSMP[®] Series


SlimDPAK (TO-252AE)



FEATURES

- Very low profile - typical height of 1.3 mm
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE
Available

RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

MECHANICAL DATA

Case: SlimDPAK (TO-252AE)

 Molding compound meets UL 94 V-0 flammability rating
 Base P/N-M3 - halogen-free, RoHS-compliant
 Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

PRIMARY CHARACTERISTICS

| | |
|---|---------------------|
| $I_{F(AV)}$ | 35 A |
| V_{RRM} | 150 V |
| I_{FSM} | 260 A |
| V_F at $I_F = 35$ A ($T_J = 125$ °C) | 0.71 V |
| T_J max. | 175 °C |
| Package | SlimDPAK (TO-252AE) |
| Circuit configuration | Single |

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

| PARAMETER | SYMBOL | V35PWM153 | UNIT |
|--|-------------------|-------------|------|
| Device marking code | | V35PWM153 | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 150 | V |
| Maximum average forward rectified current (Fig. 1) | $I_{F(AV)}^{(1)}$ | 35 | A |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I_{FSM} | 260 | A |
| Operating junction temperature range | $T_J^{(2)}$ | -40 to +175 | °C |
| Storage temperature range | T_{STG} | -55 to +175 | °C |

Notes

(1) With infinite heatsink

 (2) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$



| ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | | | |
|---|-----------------------|-----------------------------------|-------------|-------|------|----|
| PARAMETER | TEST CONDITIONS | SYMBOL | TYP. | MAX. | UNIT | |
| Instantaneous forward voltage | $I_F = 5.0\text{ A}$ | $T_J = 25\text{ }^\circ\text{C}$ | $V_F^{(1)}$ | 0.57 | - | V |
| | $I_F = 17.5\text{ A}$ | | | 0.77 | - | |
| | $I_F = 35\text{ A}$ | | | 0.94 | 1.05 | |
| | $I_F = 5.0\text{ A}$ | $T_J = 125\text{ }^\circ\text{C}$ | | 0.47 | - | |
| | $I_F = 17.5\text{ A}$ | | | 0.61 | - | |
| | $I_F = 35\text{ A}$ | | | 0.71 | 0.76 | |
| Reverse current | $V_R = 100\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$ | $I_R^{(2)}$ | 0.002 | - | mA |
| | | $T_J = 125\text{ }^\circ\text{C}$ | | 2.4 | - | |
| | $V_R = 150\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$ | | - | 0.2 | |
| | | $T_J = 125\text{ }^\circ\text{C}$ | | 6 | 20 | |
| Typical junction capacitance | 4.0 V, 1 MHz | C_J | 1420 | - | pF | |

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: pulse width $\leq 5\text{ ms}$

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | |
|--|--------------------------|-----------|--------------------|
| PARAMETER | SYMBOL | V35PWM153 | UNIT |
| Typical thermal resistance | $R_{\theta JA}^{(1)(2)}$ | 65 | $^\circ\text{C/W}$ |
| | $R_{\theta JM}^{(3)}$ | 1.5 | |

Notes

- (1) The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
(2) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient
(3) Mounted on infinite heat sink; thermal resistance $R_{\theta JM}$ - junction-to-mount

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| V35PWM153-M3/I | 0.20 | I | 4500 | 13" diameter plastic tape and reel |
| V35PWM153HM3/I ⁽¹⁾ | 0.20 | I | 4500 | 13" diameter plastic tape and reel |

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

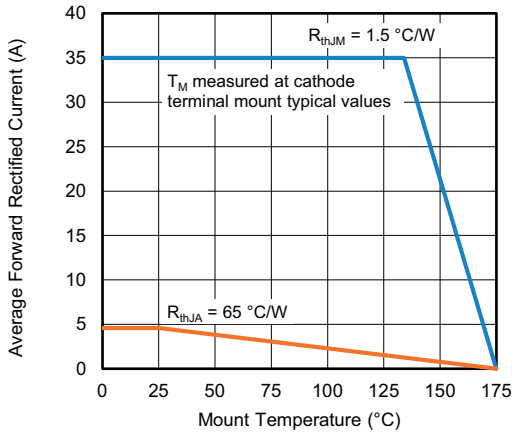


Fig. 1 - Maximum Forward Current Derating Curve

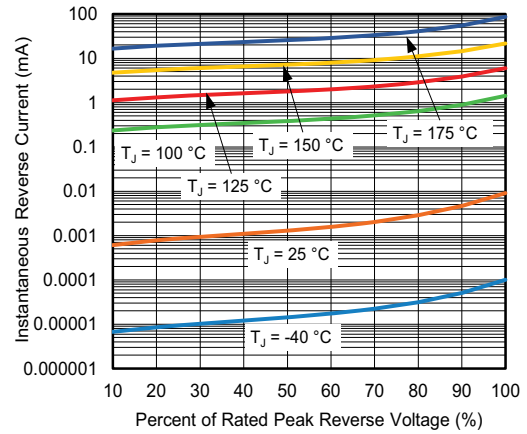


Fig. 4 - Typical Reverse Leakage Characteristics

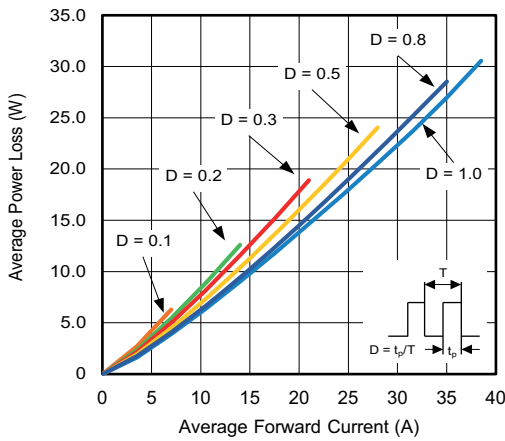


Fig. 2 - Forward Power Loss Characteristics

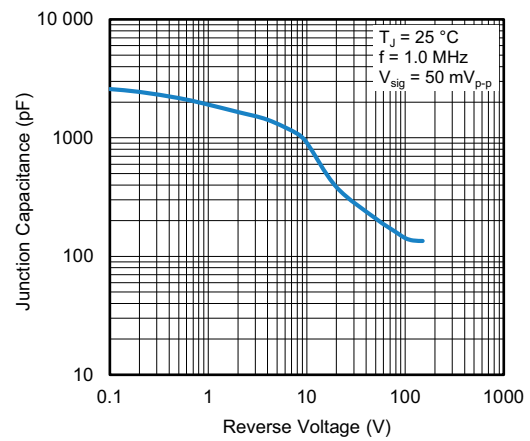


Fig. 5 - Typical Junction Capacitance

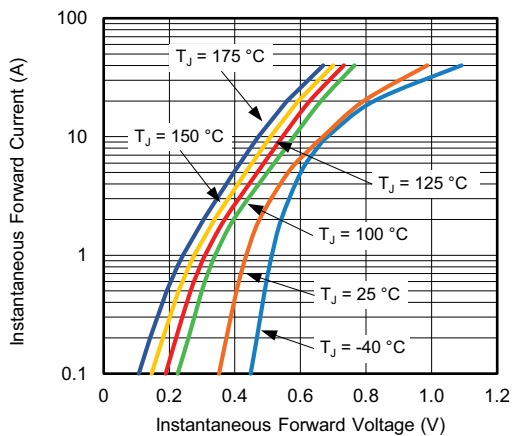


Fig. 3 - Typical Instantaneous Forward Characteristics

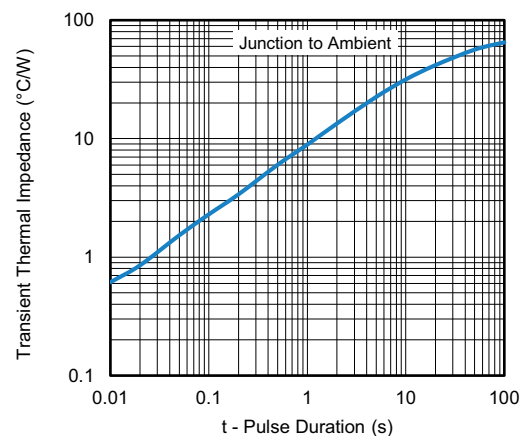


Fig. 6 - Typical Transient Thermal Impedance

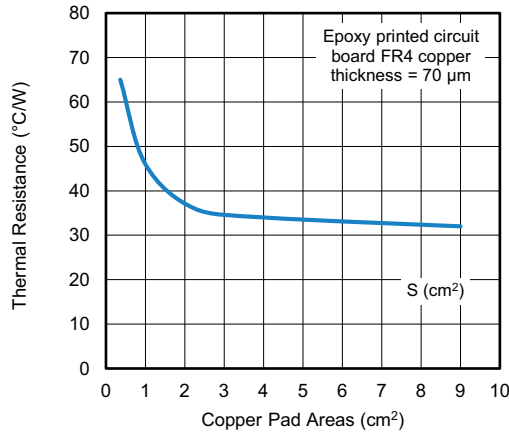
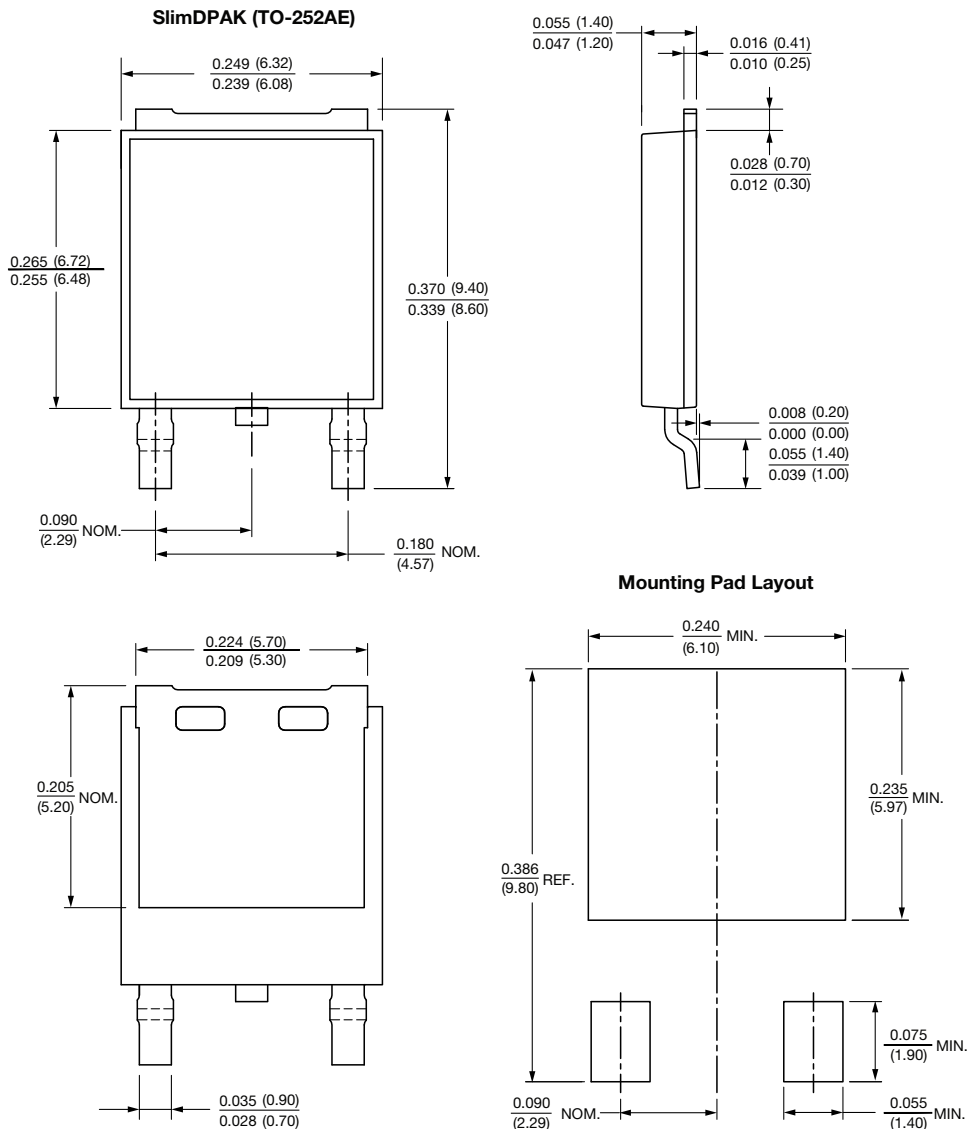


Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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